

## Product Summary

$V_{(BR)DSS}$	$R_{DS(on)TYP}$	$I_D$
100V	1.6mΩ@10V	260A

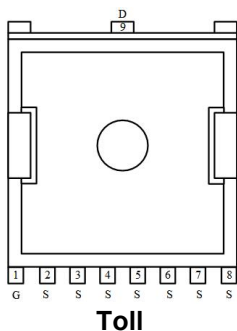
## Feature

- Fast Switching
- Low Gate Charge and Rdson
- 100% Single Pulse avalanche energy Test

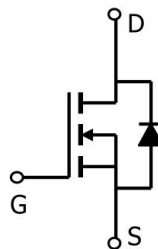
## Applications

- Power switching application
- DC-DC Converter
- Power Management

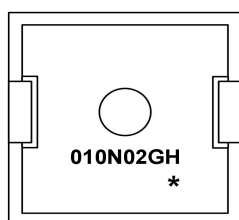
## Package



## Circuit diagram



## Marking



010N02GH : Product code  
\* : Month code

**Absolute maximum ratings (Ta=25°C, unless otherwise noted)**

Parameter	Symbol	Rating	Unit
Drain source voltage	$V_{DS}$	100	V
Gate source voltage	$V_{GS}$	$\pm 20$	V
Continuous drain current(Tc=25°C)	$I_D$	260	A
Continuous drain current(Tc=100°C)	$I_D$	175	A
Pulsed drain current	$I_{DM}$	860	A
Power dissipation(Tc=25°C)	$P_D$	280	W
Single pulsed avalanche energy <sup>1)</sup>	$E_{AS}$	1560	mJ
Thermal resistance, junction-case	$R_{\theta JC}$	0.45	°C/W
Operation and storage temperature	$T_{stg}, T_j$	-55 to 175	°C

**Electrical characteristics (Ta=25°C, unless otherwise noted)**

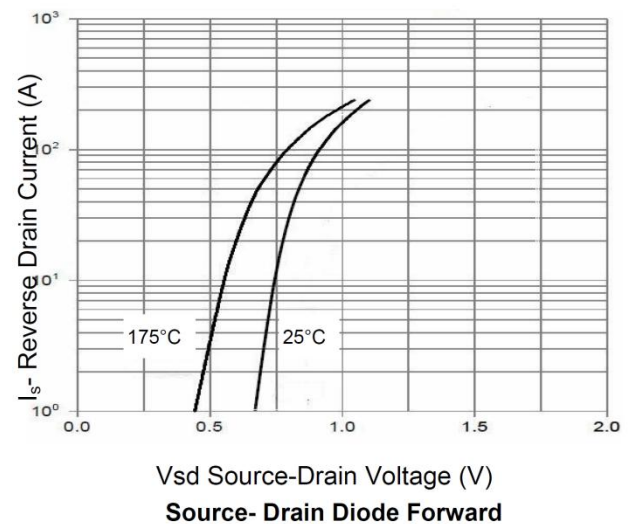
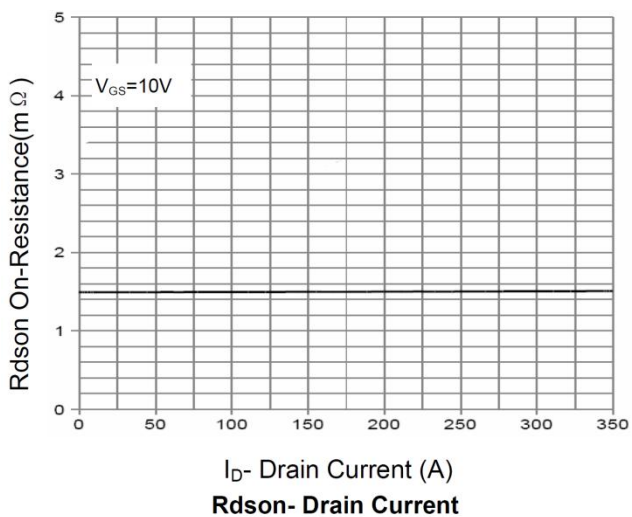
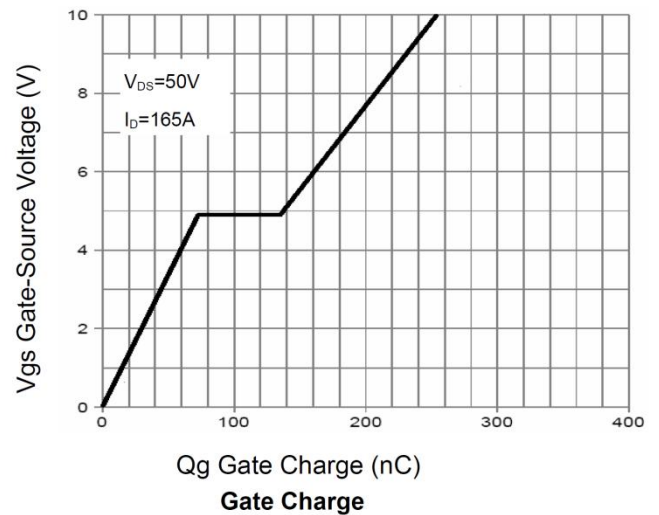
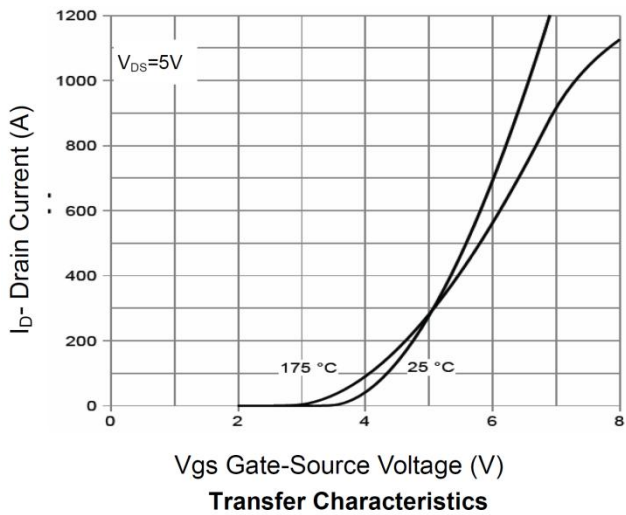
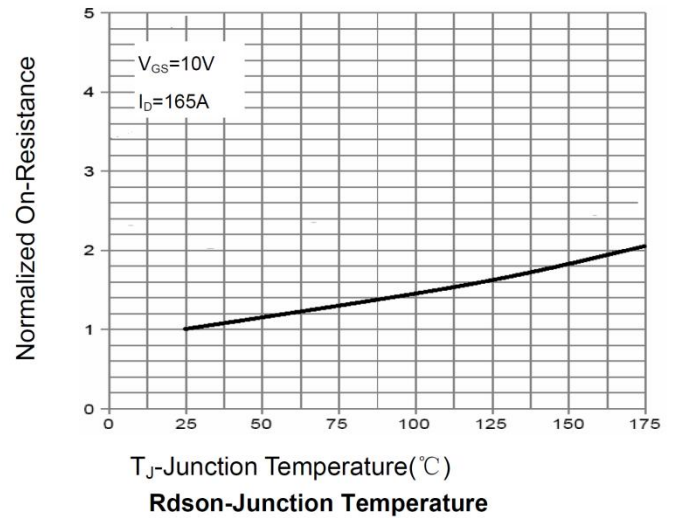
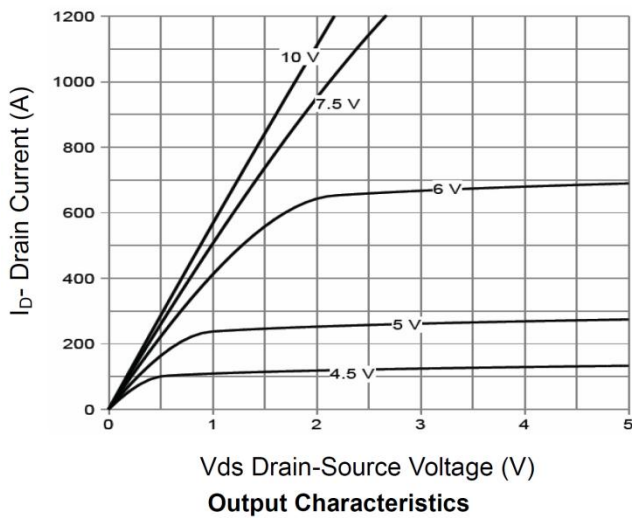
Characteristics	Symbol	Test Condition	Min	Typ	Max	Unit
Static Characteristics						
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	I <sub>D</sub> = 250μA, V <sub>GS</sub> = 0V	100	-	-	V
Drain Cut-Off Current	I <sub>DSS</sub>	V <sub>DS</sub> = 80V, V <sub>GS</sub> = 0V	-	-	1	μA
Gate Leakage Current	I <sub>GSS</sub>	V <sub>GS</sub> = ±20V, V <sub>DS</sub> = 0V	-	-	±0.1	
Gate Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = 250μA	2.7	3.2	4	V
Drain-Source ON Resistance	R <sub>DS(ON)</sub>	V <sub>GS</sub> = 10V, I <sub>D</sub> = 20A	-	1.6	2	mΩ
Dynamic Characteristics						
Input Capacitance	C <sub>iss</sub>	V <sub>DS</sub> =50V, V <sub>GS</sub> = 0V, f = 1.0MHz	-	9625	-	pF
Output Capacitance	C <sub>oss</sub>		-	1608	-	
Reverse Transfer Capacitance	C <sub>rss</sub>		-	75	-	
Switching Characteristics						
Total Gate Charge	Q <sub>g</sub>	V <sub>DS</sub> =50V , V <sub>GS</sub> =10V , I <sub>D</sub> =20A	-	160	-	nC
Gate-Source Charge	Q <sub>gs</sub>		-	31	-	
Gate-Drain Charge	Q <sub>gd</sub>		-	37	-	
Turn-On Delay Time	t <sub>d(on)</sub>	V <sub>GS</sub> = 10V, V <sub>DS</sub> = 50V, R <sub>L</sub> =2.5Ω , R <sub>G</sub> = 6.0Ω	-	35	-	ns
Rise Time	t <sub>r</sub>		-	68	-	
Turn-Off Delay Time	t <sub>d(off)</sub>		-	150	-	
Fall Time	t <sub>f</sub>		-	105	-	
Drain-Source Body Diode Characteristics						
Source-Drain Diode Forward Voltage	V <sub>SD</sub>	I <sub>S</sub> = 1A, V <sub>GS</sub> = 0V	-	-	1.2	V

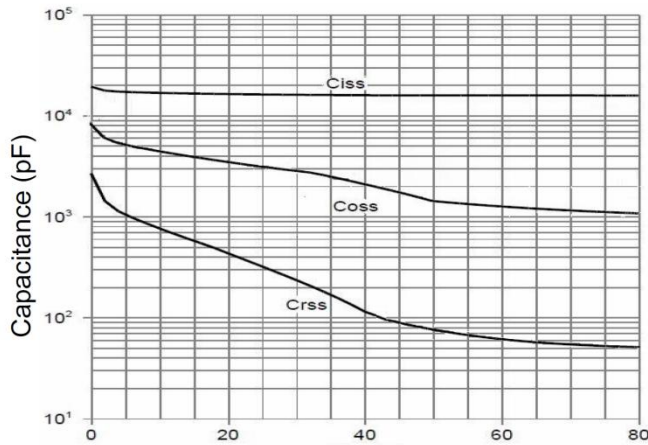
Note:

- $E_{AS}$  is tested at starting  $T_j = 25^\circ C$ ,  $V_{DD} = 50V, V_{GS} = 10V, L = 0.5mH, R_g = 25m\Omega$ ;

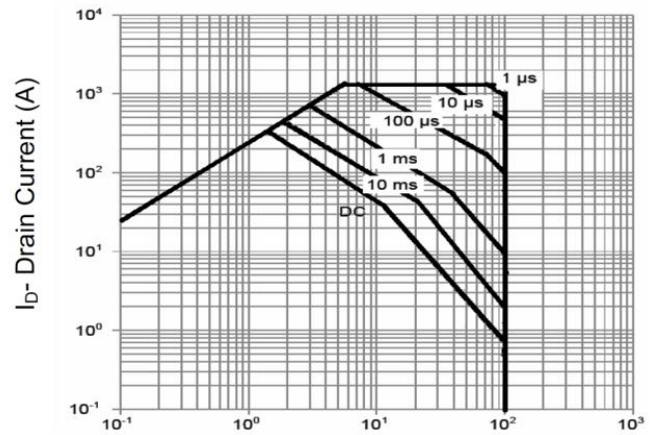


**Typical Characteristics**

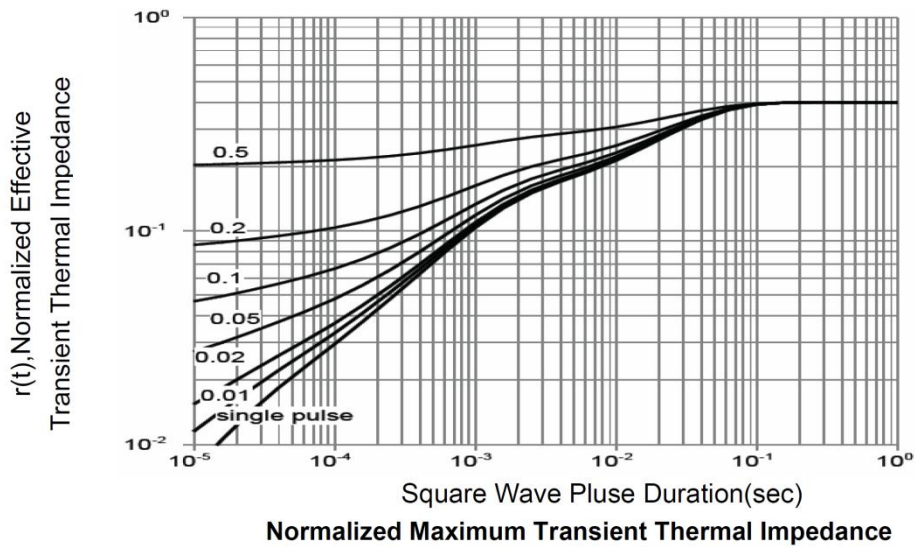




$V_{ds}$  Drain-Source Voltage (V)  
**Capacitance vs  $V_{ds}$**



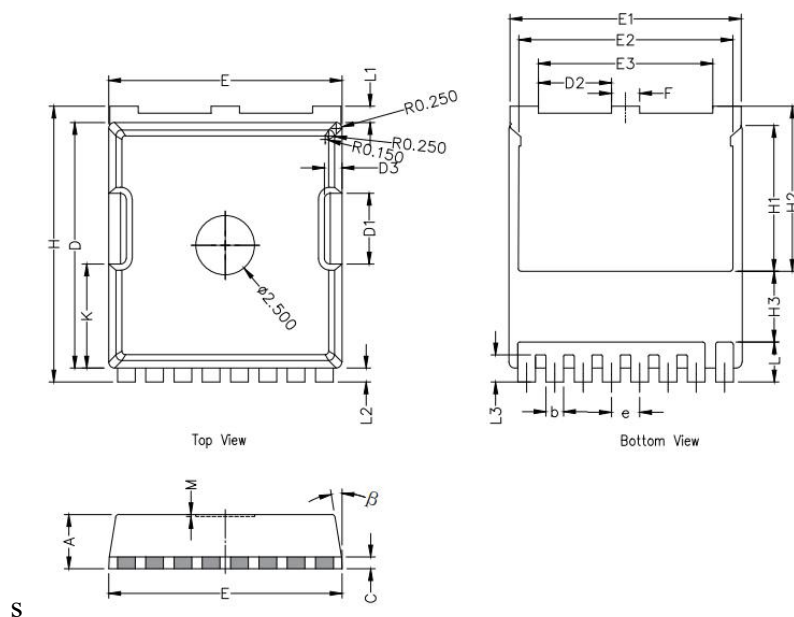
$V_{ds}$  Drain-Source Voltage (V)  
**Safe Operation Area**



**Normalized Maximum Transient Thermal Impedance**



TOLL Package Information



Symbol	Dimensions In Millimeters		
	Min.	Nom.	Max.
A	2.20	2.30	2.40
b	0.65	0.75	0.85
C	0.508 REF		
D	10.25	10.40	10.55
D1	2.85	3.00	3.15
E	9.75	9.90	10.05
E1	9.65	9.80	9.95
E2	8.95	9.10	9.25
E3	7.25	7.40	7.55
e	1.20 BSC		
F	1.05	1.20	1.35
H	11.55	11.70	11.85
H1	6.03	6.18	6.33
H2	6.85	7.00	7.15
H3	3.00 BSC		
L	1.55	1.70	1.85
L1	0.55	0.7	0.85
L2	0.45	0.6	0.75
M	0.08 REF.		
$\beta$	8°	10°	12°
K	4.25	4.40	4.55



制 修 订 记 录					
文件版本	制修日期	修订页次	修订人	变更内容	
1.0	2022/7/26		王余林	规格书建立	
1.1	2023/8/15		覃源	根据FT更新Rdson	
1.2	2024/1/30		陈志鹏	增加高温ID，修正曲线图	
批准		审核		编制	
日期		日期		日期	